

To Customer: \_\_\_\_\_

Product Type: \_\_\_\_\_

## DECLARATION LETTER for EU REACH

## 欧盟 REACH 法案声明

Follow EU REACH REGULATION No.1907/2006, our products no volatile or intentionally

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to (pre-) registration, and our products will fully comply with EU REACH REGULATION No.1907/2006 and subsequent amendments. And we guarantee that all products provide by our company follow up substances of SVHC candidate list now. comply with SVHC 241 substances

process, and verification that the flux after reflow do not contain nonylphenol substances anymore, which comply with REACH SVHC limit.

2. If product use substrate material, BPA(CAS No.:80-05-7) impurity content less than 0.3% in laminate, or if use Taiyo ink solder mask material, 2-benzyl-2-dimethylamino-4'-morpholinobutyrophenone(CAS No.:119313-12-1), 2-methyl-1-(4-methylthiophenyl)-2-morpholinopropan-1-one(CAS No.:71868-10-5) or Diphenyl(2,4,6- trimethylbenzoyl)phosphine oxide(CAS No.:75980-60-8) will be used as photo initiator for decompose and initiate polymerization, and Melamine(CAS No.:108-78-1) is used as an epoxy hardener, and the relevant product materials are subject to the reflow and curing process, the content of related substances in the final products are less than 0.1%, which comply with REACH SVHC limit.
3. If product use Henkel 8910T, 8920TC, 8062T, QMI519 epoxy, less than 1% of Bis( $\alpha,\alpha$ -dimethylbenzyl) peroxide(CAS No.:80-43-3) used as polymerization initiator. If the product uses Henkel 8910T loading adhesive, less than 1% of Hexahydro-4-methylphthalic anhydride(CAS No.:19438-60-9) used for polymerization, and the related product materials will be treated by reaction curing process, and the content of related substances in the final product is less than 0.1%, which comply with REACH SVHC limit.

到目前为止根据我公司确认:

1. 若产品有使用Indium Tachflux026s等助焊剂,在其初始化学材料中使用<70%的壬基酚(CAS No.:27193-86-8)